

APPROVAL SHEET

Customer Name : _____
Customer P/N : _____
Frequency : 16.000000 MHz
Aker Approved P/N: CXAF-016000-3-AL-22
Aker MPN : CXAF-016000-3-AL-22
Rev. : 1
ISSUE DATE : Dec.29.2022

APPROVED	CHECKED	PREPARED
		
APPROVED BY CUSTOMER		

AKER TECHNOLOGY CO., LTD.

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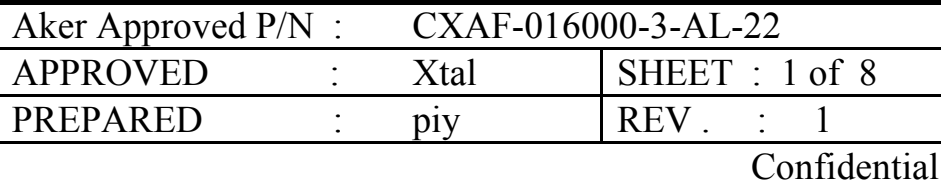
Web: www.aker.com.tw

MSL:Level 1

RoHS compliant

IATF 16949 Certified

AEC-Q200 Qualified

[illegible]

SMD CRYSTAL SPECIFICATION

1 . ELECTRICAL CHARACTERISTICS

■ Standard atmospheric conditions

Unless otherwise specified , the standard range of atmospheric conditions for making measurement and tests are as follow :

Ambient temperature : $25 \pm 5^{\circ}\text{C}$

Relative humidity : 40%~70%

If there is any doubt about the results , measurement shall be made within the following limits :

Ambient temperature : $25 \pm 3^{\circ}\text{C}$

Relative humidity : 40%~70%

■ AKER Model : CXAF-321

■ Oscillation Mode : Fundamental

■ Cutting Mode : AT CUT

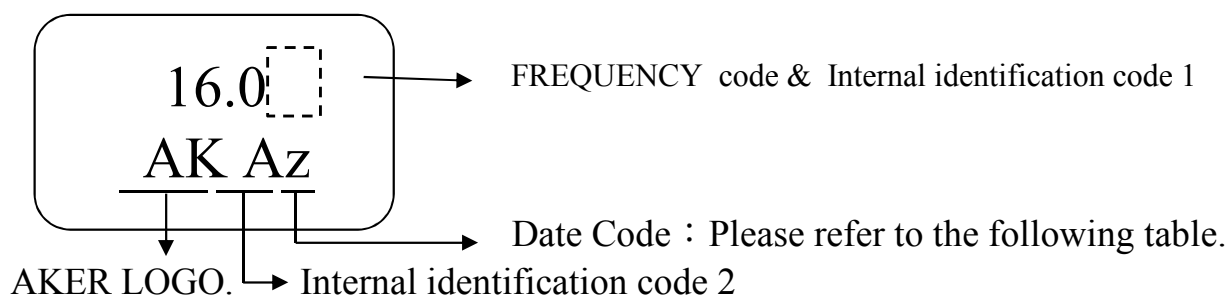
■ Measurement Equipment : 250B(Measured FL)

■ Insulation Resistance : More than 500M ohms at DC 100V

Parameters	Symbol	Electrical Spec				Notes
		Min.	Typ.	Max.	Units.	
Nominal Frequency	FL	16.000000			MHz	
Frequency Tolerance		± 15			ppm	at $25^{\circ}\text{C} \pm 3^{\circ}\text{C}$
Frequency Stability		± 50			ppm	Operating Temp (Refer 25°C)
Load Capacitance	CL	8			pF	
Aging		± 3			ppm	First Year
Operating Temperature		-40	~	125	$^{\circ}\text{C}$	
Storage Temperature Range		-55	~	150	$^{\circ}\text{C}$	
Drive Level	DL		10	200	μW	
Equivalent Series Resistance	ESR			120	Ω	@Series
Shunt Capacitance	C0	$1.04 \pm 30\%$			pF	
Motional Capacitance	C1	$2.47 \pm 30\%$			fF	
Motional Inductance	L1	$40.04 \pm 30\%$			mH	

Please kindly be noted that AKER DO NOT guarantee parts quality which involves human security application.

2 . MARKING :



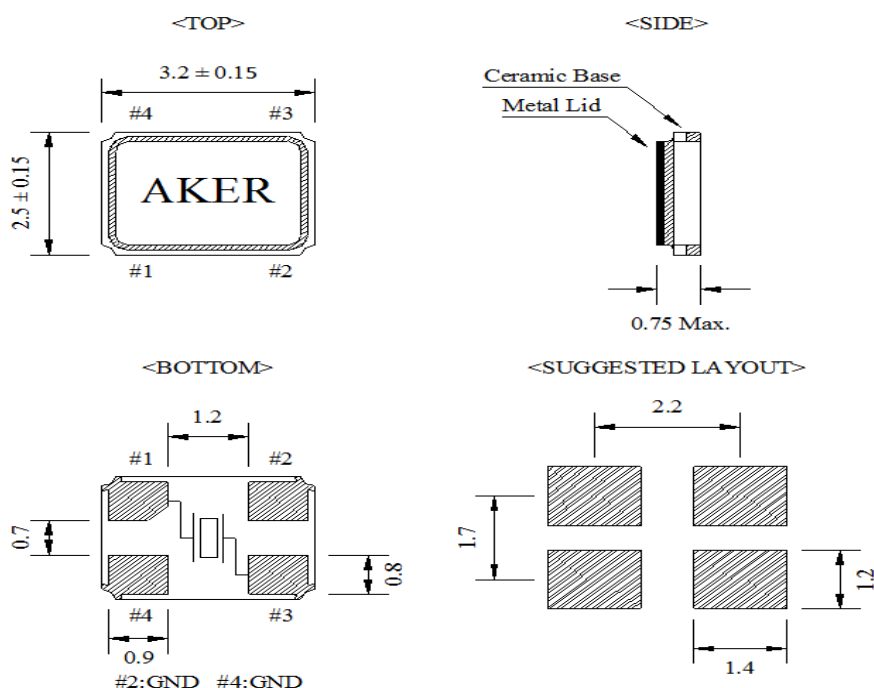
Date Code Table

Month Year			1	2	3	4	5	6	7	8	9	10	11	12
2019	2023	(4N+3)	A	B	C	D	E	F	G	H	J	K	L	M
2020	2024	(4N+0)	N	P	Q	R	S	T	U	V	W	X	Y	Z
2021	2025	(4N+1)	a	b	c	d	e	f	g	h	j	k	l	m
2022	2026	(4N+2)	n	p	q	r	s	t	u	v	w	x	y	z

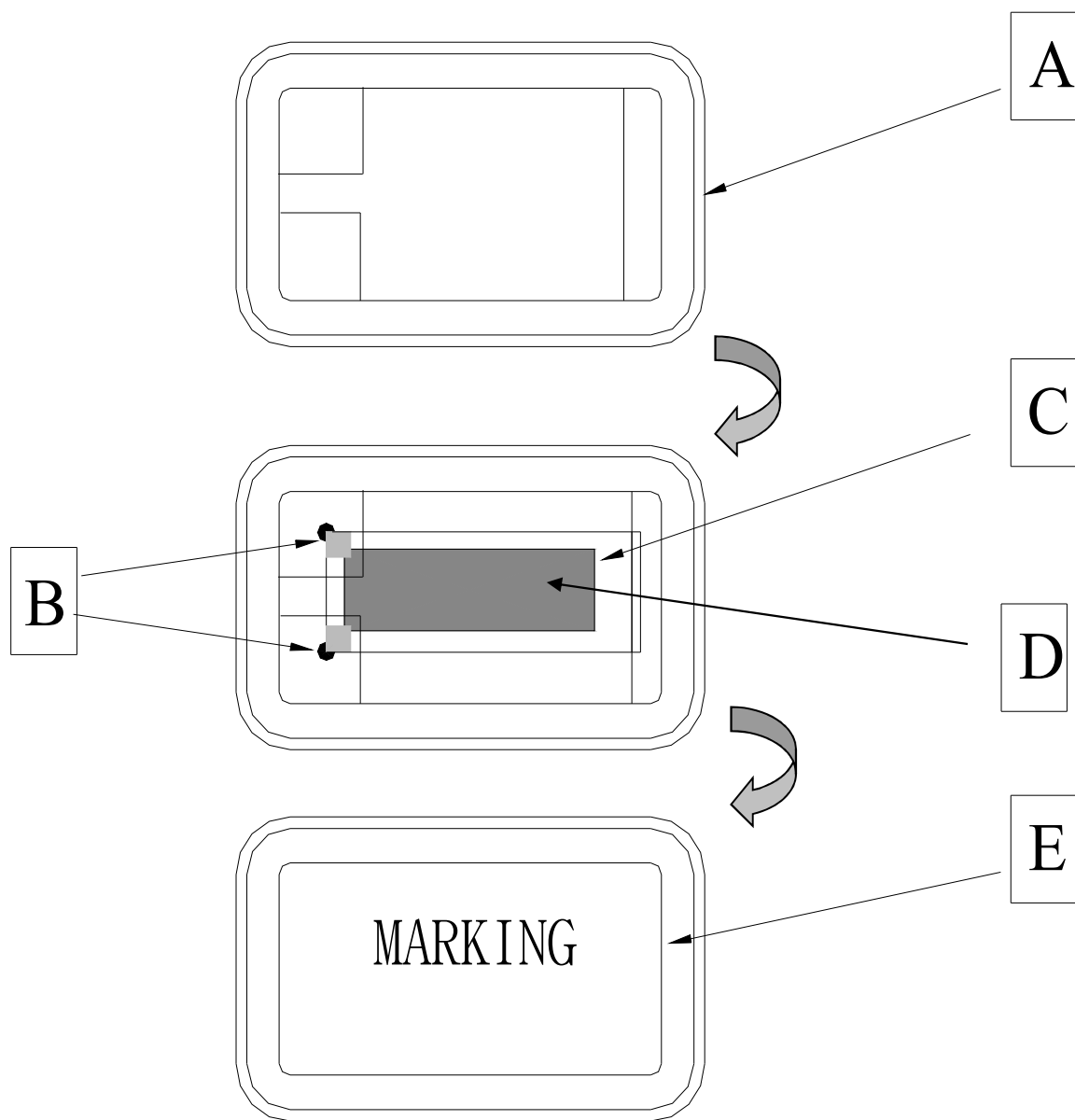
A cycle every four years

3 . DIMENSION :

(Unit : mm)



4. STRUCTURE ILLUSTRATION



COMPONENTS		MATERIALS	COMPONENTS		MATERIALS
A	Base (Package)	Ceramic(Al_2O_3)+Kovar($\text{Fe}/\text{Co}/\text{Ni}$)	D	Electrode	Cr / Ag
B	Conductive adhesive	$\text{Ag} / \text{Silicon resin}$	E	Lid	$\text{Fe}/\text{Co}/\text{Ni}$
C	Crystal blank	SiO_2			

5 . PACKING :

TAPE SPECIFICATION

(Unit : mm)



OUTLINE DIMENSION

(Unit : mm)



6. COVER TAPE ADHESION STRENGTH :



*** In the case, the cover tape is pulled off under the above conditions, the cover tape adhesion strength should be 10.2g~71.4g

Plastic tape: 10.2g~71.4g

(Cover tape adhesion strength)

7. SOLDERING REFLOW PROFILE



8. PACKING :



BOX = 3000 PCS / REEL(MAX)



SMD product packs 32 BOX=The outside box packs (3000 PCS *32 BOX = 96000 PCS)(MAX)

9 . MECHANICAL PERFORMANCE

TEST ITEMS	TEST METHODS AND TEST CONDITION	PERFORMANCE
9.1 Temperature Cycling	-55±3℃/30min maximum~+125±3℃/30min maximum , 1000cycles	To satisfy the electrical performance .
9.2 Operational Life	125℃±3℃ , 1000hrs±12hrs	
9.3 Biased Humidity	85℃±5℃&85%±5%R.H. , 1000±12hrs	
9.4 Resistance To Soldering Heat Test	Reflow test 2 times.	
9.5 High Temperature Exposure	150℃±3℃ , 1000hrs±12hrs	
9.6 Vibration Test	Freq.range: 10~2000Hz , Peak to peak amplitude:1.52mm Peak acceleration:5G (49m/s ²) , 3 direction(X, Y,Z) , 20min 12cycles each of 3 orientations.	
9.7 Mechanical Shock	100G , 6mS , 3 times for each direction(X, Y, Z) , 3 cycles	
9.8 Physical Dimension	Verify physical dimensions to the applicable device detail specification.	
9.9 Solderability	260℃ , Coated > 95%	
9.10 Board Flex	PCB=100*40(mm) , Bending=2 mm (min) , Duration=60+5/-0 sec	
9.11 External Visual	Inspect device construction and marking.	
9.12 Terminal Strength	A force of 17.7N for 60 seconds.	